

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	0	interposer and (wafer adj scale adj package) and glass and via and solder and @ad<19980320	USPAT; US-PGP UB; EPO; JPO; IBM_TD B	2004/10/05 13:10
2	BRS	L2	1	interposer and (wafer adj scale adj package) and via and solder and @ad<19980320	USPAT; US-PGP UB; EPO; JPO; IBM_TD B	2004/10/05 13:10